COMPLIANT

HALOGEN FREE



Vishay General Semiconductor

Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier



DESIGN SUPPORT TOOLS



PRIMARY CHARACTERISTICS				
I _{F(AV)}	5 A			
V _{RRM}	60 V			
I _{FSM}	60 A			
V _F at I _F = 5 A (125 °C)	0.52 V			
T _J max.	175 °C			
Package	SlimSMAW (DO-221AD)			
Circuit configuration	Single			

FEATURES

Low-profile package

• Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C

RoHS

• AEC-Q101 qualified available

- Automotive ordering code: base P/NHM3

Compatible to SOD-128 package case outline

· Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

MECHANICAL DATA

Case: SlimSMAW (DO-221AD)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	VSS8D5M6	UNIT	
Device marking code		V5M6		
Maximum repetitive peak reverse voltage	V _{RRM}	60	V	
Maximum average forward rectified current (fig.1)	I _{F(AV)} (1)	5		
	I _{F(AV)} (2)	2.7	A	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	I _{FSM} 60		
Operating junction temperature range	T _J ⁽³⁾	-40 to +175	°C	
Storage temperature range	T _{STG}	T _{STG} -55 to +175		

Notes

- (1) Mounted on 30 mm x 30 mm AL PCB pad area
- (2) Free air, mounted on recommended copper pad area
- (3) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CO	TEST CONDITIONS		TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 2.5 A	$T_A = 25 ^{\circ}C$	V _F ⁽¹⁾	0.50	-	V
	I _F = 5 A			0.58	0.66	
	I _F = 2.5 A	T _A = 125 °C		0.40	-	
	I _F = 5 A			0.52	0.60	
Reverse current	V - 60 V	$V_R = 60 \text{ V}$ $T_A = 25 \text{ °C}$ $T_A = 125 \text{ °C}$	I _R ⁽²⁾	-	0.35	- mA
	v _R = 60 v			2	7.0	
Typical junction capacitance	4.0 V, 1 MH	4.0 V, 1 MHz		620	-	pF

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise specified)					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Typical thermal resistance	R ₀ JA (1)(2)	120	150	°C/W	
Typical thermal resistance	R _{0JM} (3)	12	15		

Notes

 $^{(1)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

(2) Thermal resistance junction-to-ambient to follow JEDEC® 51-2A, device mounted on FR4 PCB, 2 oz., standard footprint

(3) Thermal resistance junction-to-mount to follow JEDEC 51-14 transient dual interface test method (TDIM)

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
VSS8D5M6-M3/H	0.033	Н	3500	7" diameter plastic tape and reel		
VSS8D5M6-M3/I	0.033	I	14 000	13" diameter plastic tape and reel		
VSS8D5M6HM3/H (1)	0.033	Н	3500	7" diameter plastic tape and reel		
VSS8D5M6HM3/I (1)	0.033	I	14 000	13" diameter plastic tape and reel		

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

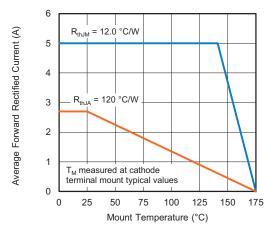


Fig. 1 - Maximum Forward Current Derating Curve

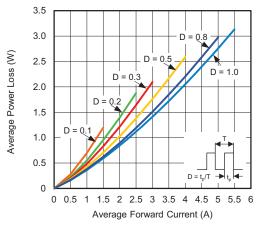


Fig. 2 - Forward Power Loss Characteristics

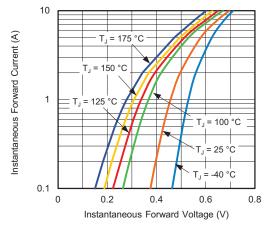


Fig. 3 - Typical Instantaneous Forward Characteristics

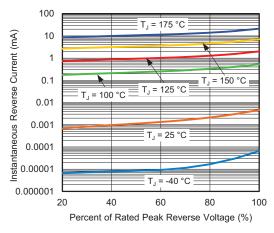


Fig. 4 - Typical Reverse Leakage Characteristics

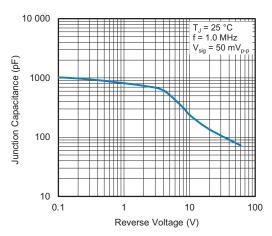


Fig. 5 - Typical Junction Capacitance

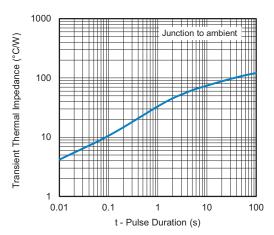
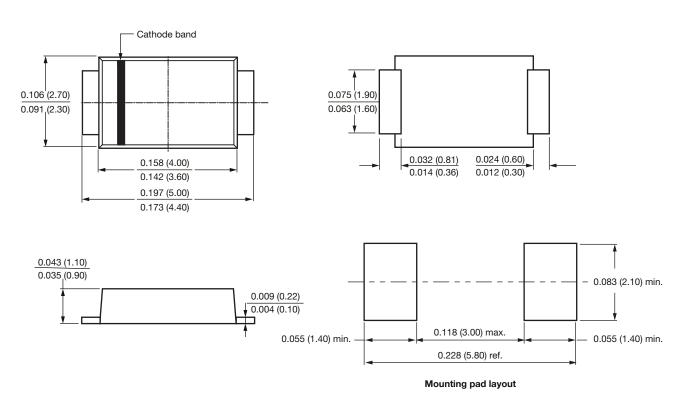


Fig. 6 - Typical Transient Thermal Impedance

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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SlimSMAW (DO-221AD)





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